isola

DE104

DE104 offers excellent thermal resistance, due to its special resin system and a low coefficient of thermal expansion in the Z-axis.

The glass transition temperature (Tg) is 135° C (DSC). Time to delamination of the laminate at a temperature of 260° C is greater 12 minutes and the decomposition temperature (Td) is 315° C. The product is listed as FR-4 and can be processed using standard parameters. DE104 multilayer (ML) corresponds to NEMA-grade FR-4 and meets the requirements of IPC-4101C /21.

ORDERING INFORMATION:

Contact your local sales representative or visit www.isola-group.com for further information.

Isola Group 3100 West Ray Road Suite 301 Chandler, AZ 85226 Phone: 480-893-6527 Fax: 480-893-1409 info@isola-group.com Isola Asia Pacific (Hong Kong) Ltd. Unit 3512 - 3522, 35/F No. 1 Hung To Road, Kwun Tong, Kowloon, Hong Kong Phone: 852-2418-1318 Fax: 852-2418-1533 info.hkg@isola-group.com

Isola GmbH Isola Strasse 2 D-52348 Düren, Germany Phone: 49-2421-8080 Fax: 49-2421-808164 info-dur@isola-group.com

Performance

Tg 135°C Td 315°C Dk 4.37 Df 0.022

zIPC- 4101C /21 /24 /26 /98 /101 /126 UL - File Number E41625 Qualified to UL's MCIL Program

Product Features

- · Industry Recognition
 - UL File Number: E41625
 - Qualified to UL's MCIL Program
 - RoHS Compliant
- · Performance Attributes
- Processing Advantages
 - UV blocking and AOI fluorescence

Product Availability

- · Standard Material Offering: Laminate
 - 2 to 93 mil (0.05 to 2.4 mm)
 - Available in full size sheet or panel form
- · Copper Foil Type
 - HTE Grade 3
 - RTF (Reverse Treat Foil)
- · Copper Weight
 - ½ to 2 oz (18 to 70 μm) available
 - Heavier copper available
 - Thinner copper foil available
- · Standard Material Offering: Prepreg
 - Roll or panel form
 - Tooling of prepreg panels
- · Glass Fabric Availability
 - E-glass
 - Square weave glass
 - Mechanically spread glass

DE104 Specifications

			Units	Test Method
Property		Typical Value	Metric (English)	IPC-TM-650 (or as noted)
Glass Transition Temperature (Tg) by DSC		135	°C	2.4.25
Decomposition Temperature (Td) by TGA @ 5% weight loss		315	°C	2.4.24.2
Time to Delaminate by TMA (Copper removed)	A. T260 B. T288	12 _	°C Minutes	2.4.24.1
Z-Axis CTE	A. Pre-Tg B. Post-Tg C. 50 to 260°C, (Total Expansion)	70 250 4.2	ppm/°C ppm/°C %	2.4.24
X/Y-Axis CTE	Pre-Tg	16/13	ppm/°C	2.4.24.1
Thermal Conductivity		0.36	W/mK	ASTM E1952
Thermal Stress 10 sec @ 288°C (550.4°F)	A. Unetched B. Etched	Pass	Pass Visual	2.4.13.1
Dk, Permittivity	A. @ 100 MHz B. @ 500 MHz C. @ 1 GHz D. @ 2 GHz E. @ 5 GHz	4.46 4.40 4.37 4.35 4.32	-	2.5.5.3 2.5.5.9 2.5.5.5 Bereskin Stripline
Df, Loss Tangent	A. @ 100 MHz B. @ 500 MHz C. @ 1 GHz D. @ 2 GHz	0.020 0.021 0.022 0.023	_	2.5.5.3 2.5.5.9 2.5.5.5
Dk, Permittivity	@ 5 GHz	0.024	-	
Volume Resistivity	A. C-96/35/90 B. After moisture resistance C. At elevated temperature	- 1.3 x 10 ⁶ 3.4 x 10 ⁷	M⊠-cm	2.5.17.1
Surface Resistivity	A. C-96/35/90 B. After moisture resistance C. At elevated temperature	- 1.0 x 10 ⁶ 7.2 x 10 ⁶	MØ	2.5.17.1
Dielectric Breakdown		>50	kV	2.5.6
Arc Resistance		105	Seconds	2.5.1
Electric Strength (Laminate & laminated prepreg)		54 (1350)	kV/mm (V/mil)	2.5.6.2
Comparative Tracking Index (CTI)		2	Class (Volts)	UL 746A ASTM D3638
Peel Strength	A. Low profile copper foil and very low profile copper foil all copper foil >17 Mm [0.669 mil] B. Standard profile copper 1. After thermal stress 2. At 125°C (257°F) 3. After process solutions	1.23 (7.0) 1.58 (9.0) 1.23 (7.0) 1.58 (9.0)	N/mm (lb/inch)	2.4.8 2.4.8.2 2.4.8.3 2.4.8.3
Flexural Strength	A. Length direction B. Cross direction	84,000 65,200	lb/inch ²	2.4.4
Tensile Strength	A. Length direction B. Cross direction	57,000 42,400	lb/inch ²	ASTM D3039
Moisture Absorption		0.3	%	2.6.2.1
Flammability (Laminate & laminated prepreg)		V-0	Rating	UL 94
Max Operating Temperature		130	°C	UL 796

The data, while believed to be accurate and based on analytical methods considered to be reliable, is for information purposes only. Any sales of these products will be governed by the terms and conditions of the agreement under which they are sold.

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